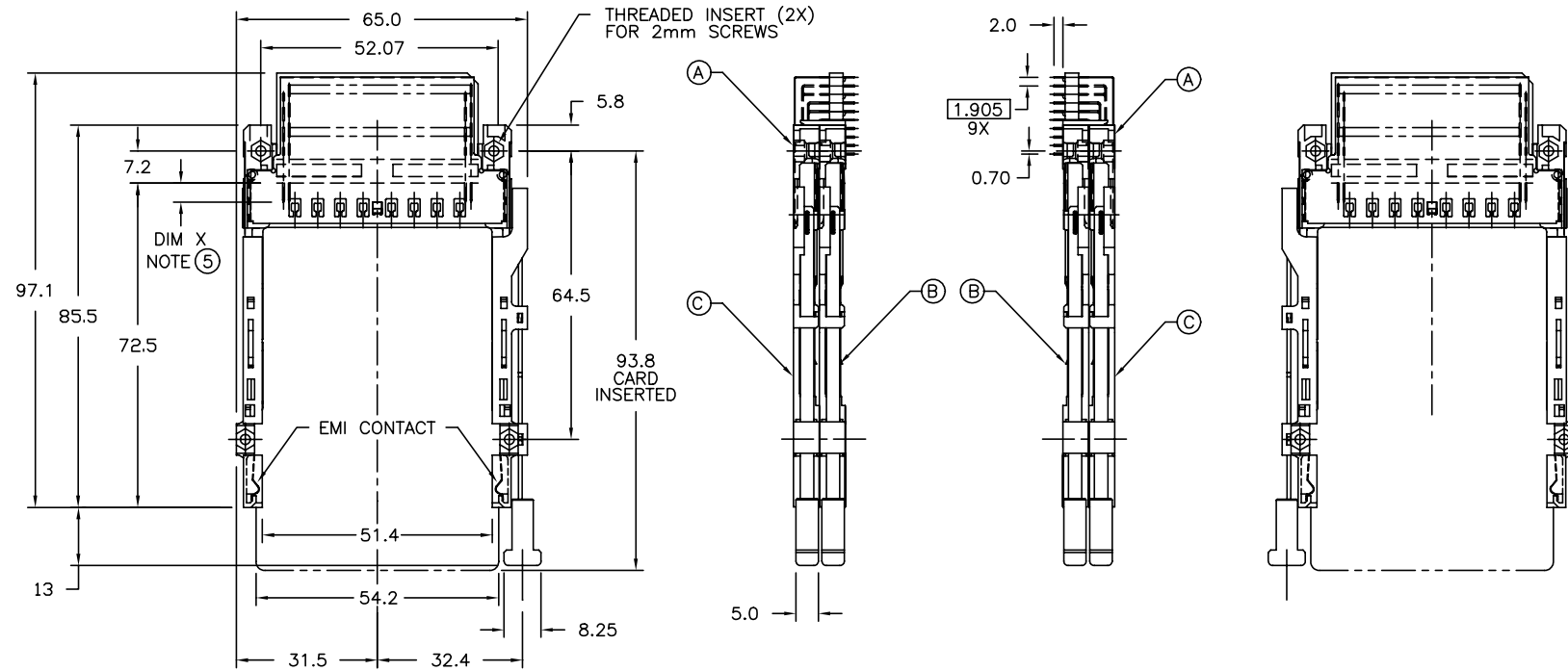
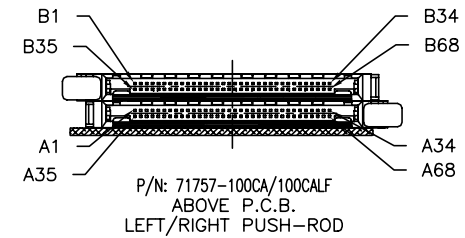
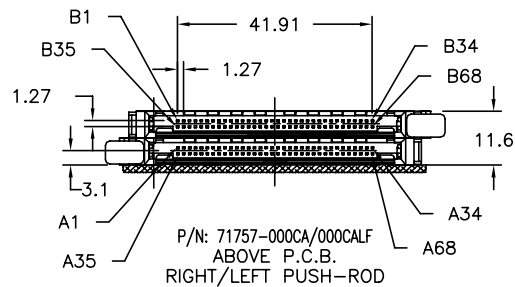
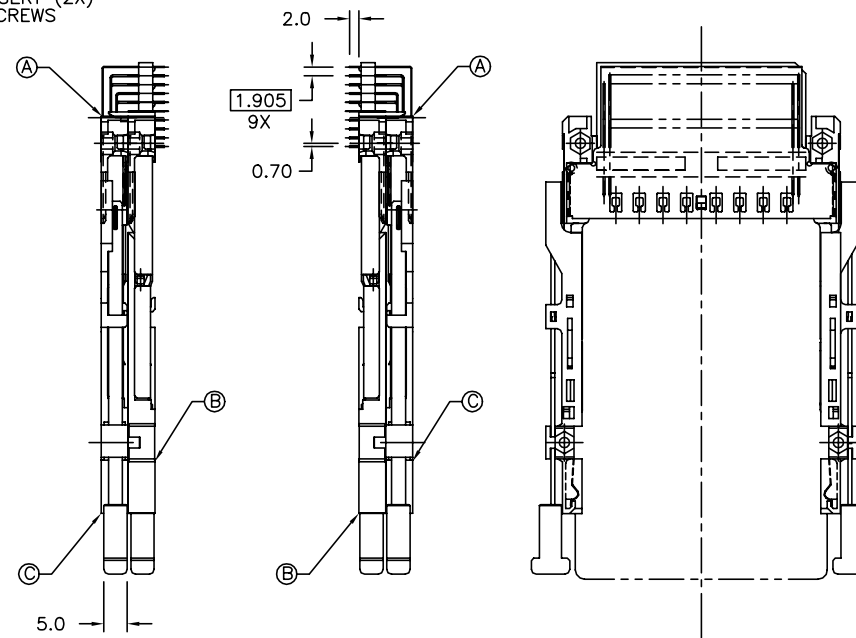
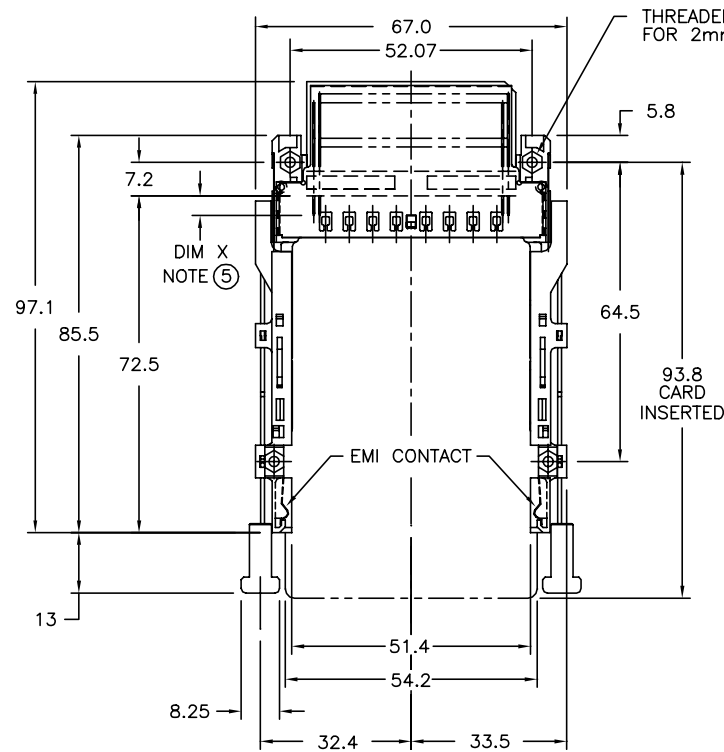


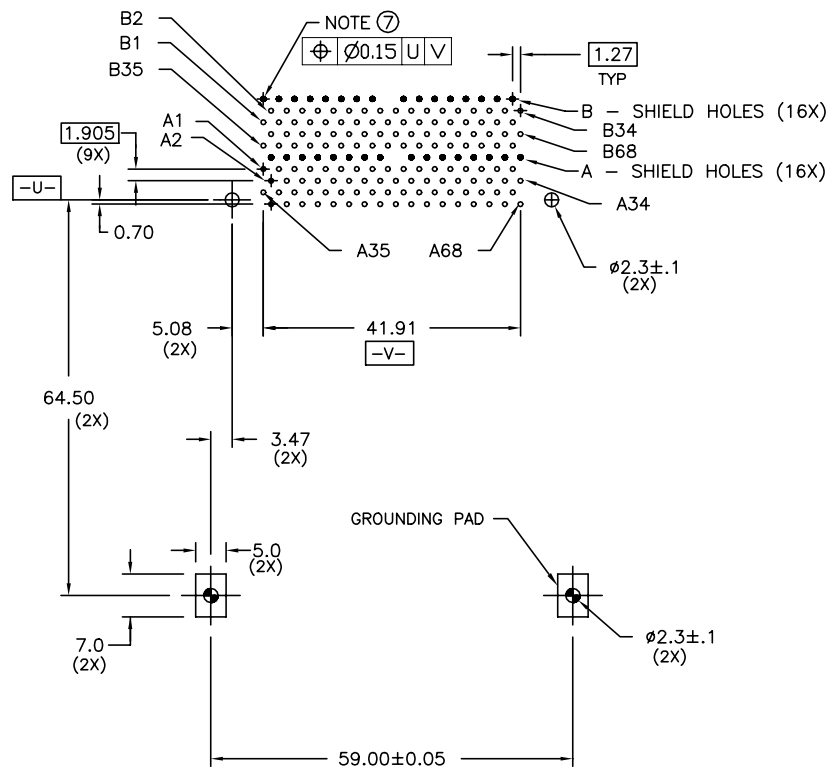
PRODUCT NUMBER	DOUBLE - DECK HEADER ①	LOWER EJECT MECHANISM ②	UPPER EJECT MECHANISM ③
71757-200CALF	71257-0000LF	72336-000CA	72336-000CA
71757-300CALF	71257-0000LF	72336-100CA	72336-100CA
71757-200CA	71257-0000	72336-000CA	72336-000CA
71757-300CA	71257-0000	72336-100CA	72336-100CA

mat'l. code			surface		tolerance		projection		product family		
			ISO1302 ✓		ISO406 ISO1101				PCMCIA		
ltr ecn nodr			date		tolerances unless otherwise specified		title				
J	ELX-N-007946	ZK	11/01/11	angle	line	0.X±0.3			R/A CARDBUS DOUBLE DECK ASSEMBLY		
k	ELX-N-011406	ZK	04/07/12			0.XX±0.13					
D	V70389	RHG	03/25/97			0'±2' 0.XXX±0.05					
E	V71446	RHG	10/07/97	dr	D.SHEAFFER	08/31/95		dwg no			
F	V81800	CGC	10/20/98	engr	D.BRANN	08/31/95			71757		A4
G	V12164	TFG	08/16/01	chr	D.BRANN	08/31/95					
H	N05-0054	WB	03/01/05	appd	D.BRANN	08/31/95			type Product Customer Drawing		
sheet	revision	K	K	K							
index	sheet	1	2	3							



PRODUCT NUMBER	DOUBLE - DECK HEADER ①	LOWER EJECT MECHANISM ②	UPPER EJECT MECHANISM ③
71757-000CALF	71257-0000LF	72336-100CA	72336-000CA
71757-100CALF	71257-0000LF	72336-000CA	72336-100CA
71757-000CA	71257-0000	72336-100CA	72336-000CA
71757-100CA	71257-0000	72336-000CA	72336-100CA

mat'l. code	surface	tolerance	projection	product family
ISD1302	✓	ISD406 ISD1101	⊕	PCMCIA
l'tec n nodr	date	tolerances unless otherwise specified	title	
K		0.X±0.3	MM	R/A CARDBUS DOUBLE DECK ASSEMBLY
		0.XX±0.13	scale 3/4	
		0.XXX±0.05		
	dr	D.SHEAFFER	08/31/95	dwg no
	enr	D.BRANN	08/31/95	sheet 2 of 3
	chr	D.BRANN	08/31/95	size
	appd	D.BRANN	08/31/95	A4
sheet index	revision			type Product Customer Drawing



NOTES:

- 1 8mm MIN CARD EJECT.
- 2 EJECT TRAVEL: 9.5mm
- 3 MATERIAL:
 - 3.1 HEADER ASSY:
HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
PIN: COPPER ALLOY
 - 3.2 EJECT MECHANISM ASSY:
HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
COVER PLATE, EJECT PLATE, LINK ARM,
PUSH ROD: STAINLESS STEEL
EMI CONTACT: PHOSPHOR BRONZE
- 4 FINISH (PIN)
UNDER PLATING: 0.5um Ni
CONTACT AREA: 0.076 µm MIN. GOLD

SOLDER TAIL(TIN LEAD OPTION): 2.5um Sn-Pb
SOLDER TAIL(LEAD FREE OPTION): 2.5um PURE TIN

⑤

DIM "X"	4.25±0.1	3.5±0.1	5.0±0.1
PIN NUMBER	OTHERS	36,67	1,17,34,35,51,68

- 6 RECOMMENDED SCREW TORQUE: 1.0 TO 1.5 MAX in-lbs. (1.2-1.7 cm-kgs).
RECOMMENDED HOLD DOWN: 2mm SCREWS AND NUTS
SEE 95121 AND 92869 FOR INFORMATION.
- ⑦ RECOMMENDED DIAMETER IS Ø1.0. FOR PROCESSES USING PASTE REFLOW, HOLE MAY BE AS SMALL AS Ø0.79.
- ⑧ IF LEAD FREE P/N.THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
- ⑨ IF LEAD FREE P/N.THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DISCRIBLED IN GS-22-008
- ⑩ LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION
- 11 PRODUCT SPEC: 110-263

mat'l. code		surface		tolerance		projection		product family	
		ISO1302		ISO406		ISO1101		PCMCIA	
l t r e c n n o d r d a t e		tolerances unless otherwise specified		tolerances unless otherwise specified		tolerances unless otherwise specified		title	
K		angle		0.X±0.3		MM		R/A CARDBUS DOUBLE DECK ASSEMBLY	
		σ±2°		0.XX±0.13		scale 3/4		dwg no	
		dr		D.SHEAFFER		08/31/95		sheet 3 of 3	
		engr		D.BRANN		08/31/95		71757	
		chr		D.BRANN		08/31/95		A4	
		appd		D.BRANN		08/31/95		type	
sheet		revision						Product Customer Drawing	
index		sheet							